

# DATA SHEET

## **TDA1082** East-West correction driver circuit

Product specification  
File under Integrated Circuits, IC02

March 1986

**East-West correction driver circuit****TDA1082****GENERAL DESCRIPTION**

The TDA1082 is a monolithic integrated circuit driving east-west correction of colour tubes in television receivers. The circuit can be used for class-A and class-D operation and incorporates the following functions:

- differential input amplifier
- squaring stage
- differential output amplifier with driver stage
- protection stage with threshold
- switching off the correction during flyback
- voltage stabilizer

**QUICK REFERENCE DATA**

Supply voltage (pin 1)	$V_P$	typ.	12	V
Current consumption	$I_P$	typ.	17	mA
Total power dissipation	$P_{tot}$	max.	600	mW
Operating ambient temperature range	$T_{amb}$		0 to + 70	°C
Collector voltage drift external transistor	$\Delta V_C$	typ.	0,7	V

**PACKAGE OUTLINE**

16-lead DIL; plastic (SOT38); SOT38-1; 1996 November 19.

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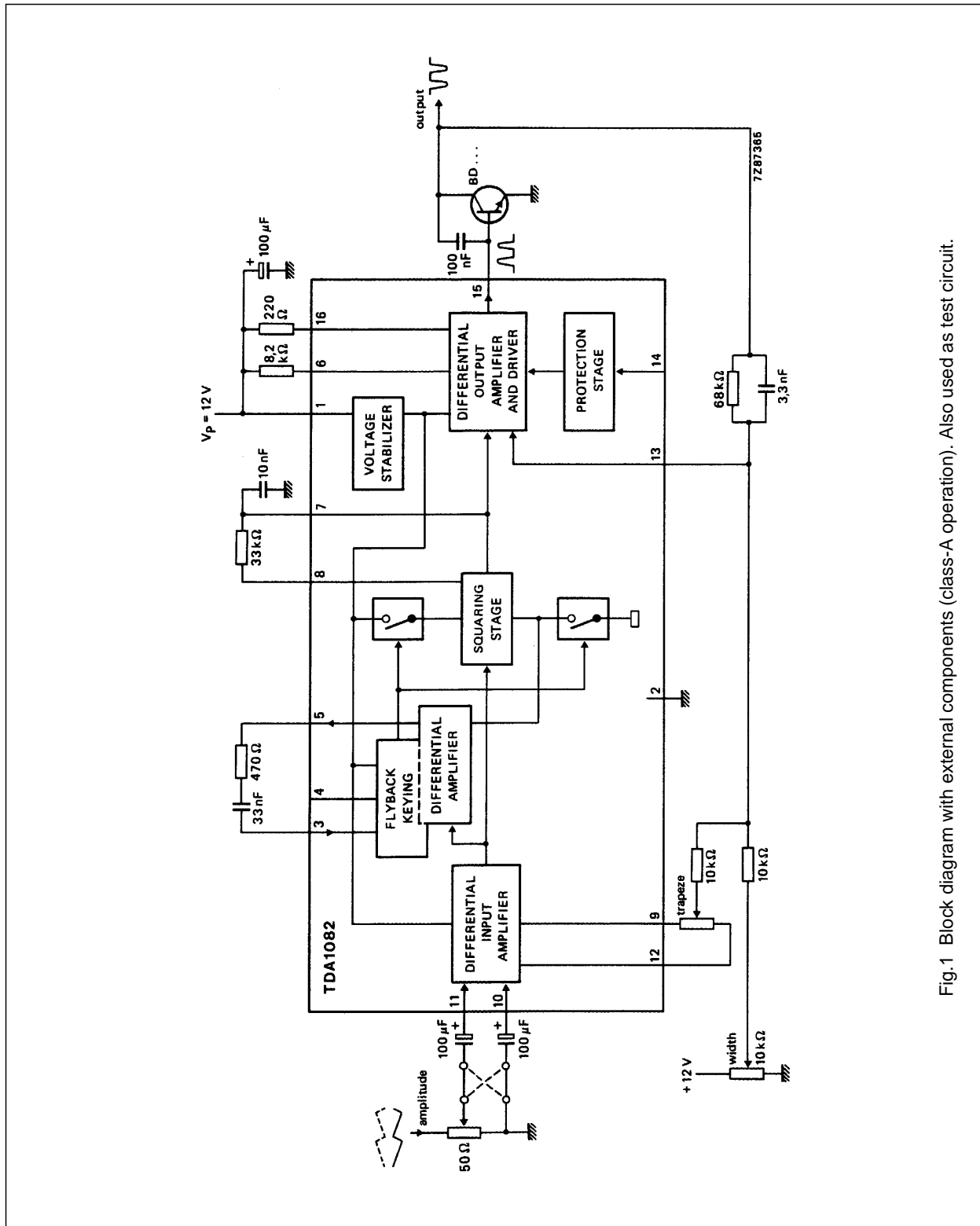


Fig. 1 Block diagram with external components (class-A operation). Also used as test circuit.

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**RATINGS**

Limiting values in accordance with the Absolute Maximum System (IEC 134)

Supply voltage (pin 1)	$V_P$	max.	16	V
Output current (pin 15)	$-I_O$	max.	50	mA
Total power dissipation	$P_{tot}$	max.	600	mW
Storage temperature range	$T_{stg}$		-25 to +150	°C
Operating ambient temperature range	$T_{amb}$		0 to +70	°C

**Voltages**

with respect to ground (pin 2)		min.	max.	
Pins 1, 5, 7, 8, 9, 12, 13 and 16		0	16	V
Pins 3 and 4		0	-	V
Pins 10, 11 and 15		0	5	V

**Currents**

Pins 3, 4 and 6		-	5	mA
Pin 14		0	1,5	mA
Pins 15 and 16 ( $-I_{15}$ and $+I_{16}$ )		0	50	mA

**CHARACTERISTICS**

$V_P = 12$  V (range 10,5 to 14 V);  $T_{amb} = 25$  °C; measured in circuit Fig.1 with colour tube A66-500X; unless otherwise specified

**Supply**

Voltage range	$V_P$	10,5	to	14	V
Voltage peak value	$V_{PM}$	max.		15	V
Current range	$I_P$	11	to	30	mA
Current typical value	$I_P$	typ.		17	mA

**Sawtooth signal** (pin 10 or 11)

Input voltage d.c. value	$V_i$	typ.		2,5	V
Input resistance	$R_i$	typ.		5,6	k $\Omega$
			<	7,0	k $\Omega$

**Correcting signals** (pin 13)

Input voltage d.c. value	$V_{13}$	typ.		0,6	V
Input current	$I_{13}$	typ.		0,5	mA

**Flyback keying** (pin 3)

Input current range	$I_3$	0,05	to	5	mA
Peak value, $d = 5\%$	$I_3$	typ.		20	mA

**Threshold** (pin 14)

Input voltage at $I_{14} = 200$ $\mu$ A	$V_i$	typ.		8	V
for switching off the driver stage			7,2	to	8,8
					V

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**Output stage** (pin 6)

Generator current	$I_6$	typ.	1	mA
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**Flyback differential amplifier** (pin 5)

D.C. value output voltage	$V_5$	typ.	6	V
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Output resistance	$R_5$	typ.	5,6	k $\Omega$
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**Squaring stage** (pin 7)

D.C. value output voltage	$V_7$	typ.	6	V
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Peak to peak value output voltage	$V_{7(p-p)}$	typ.	1,5	V
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Output resistance	$R_7$	5,6 to	9,4	k $\Omega$
		typ.	7,5	k $\Omega$

**Correction trapezoidal deformation** (pins 9 and 12)

D.C. voltage	$V_{9,12}$	typ.	5	V
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Output resistance	$R_{9,12}$	typ.	7,5	k $\Omega$
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**Driver output** (pin 15)

Output current	$-I_{15}$	<	50	mA
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**Drift of d.c. collector voltage**

Of external transistor in closed loop

$T_{amb} = 15 \text{ to } 70 \text{ }^\circ\text{C}; V_{CO} = 8 \text{ V}$	$\Delta V_C$	typ.	0,7	V
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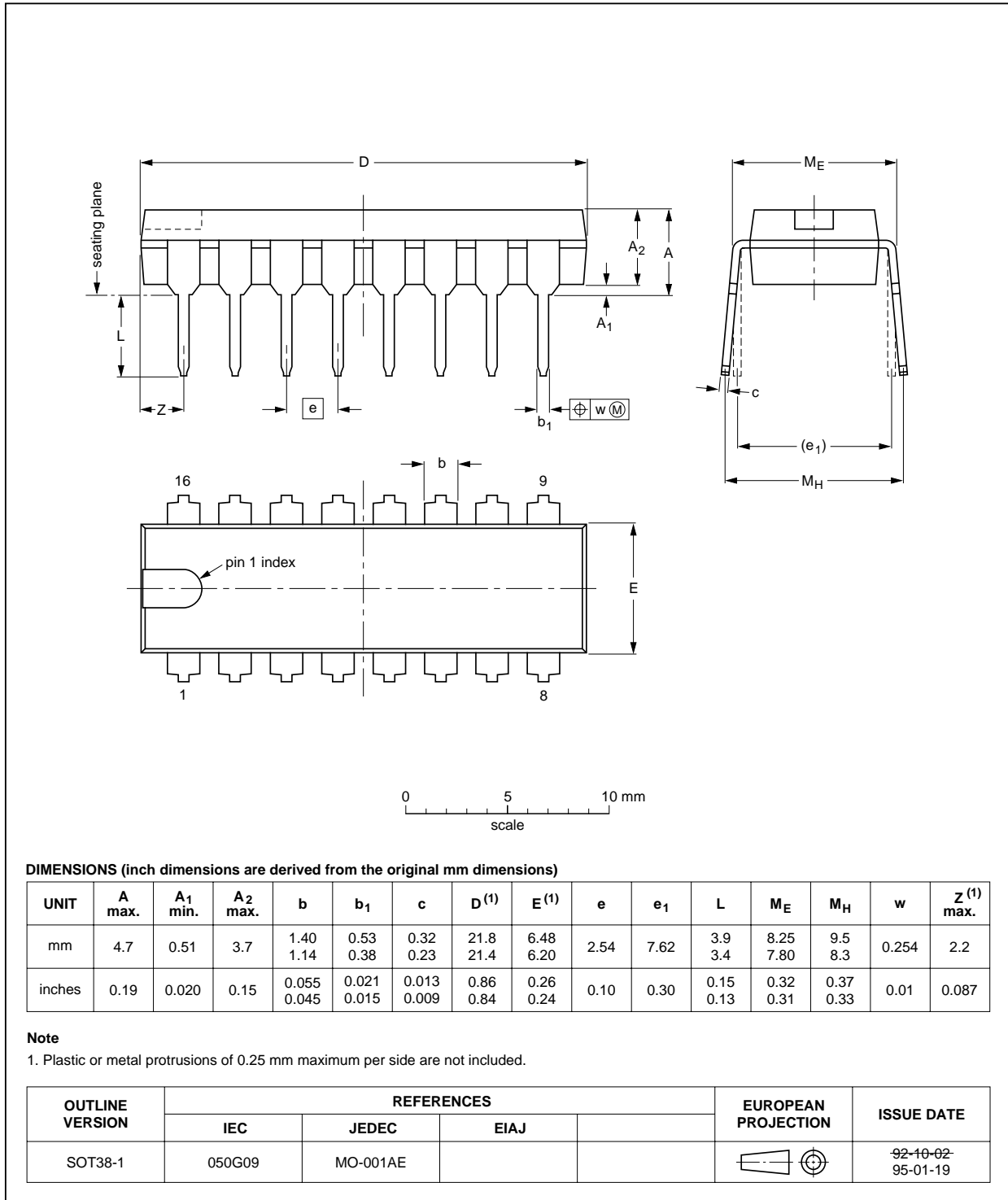
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PACKAGE OUTLINE

DIP16: plastic dual in-line package; 16 leads (300 mil); long body

SOT38-1



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### SOLDERING

#### Introduction

There is no soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and surface mounted components are mixed on one printed-circuit board. However, wave soldering is not always suitable for surface mounted ICs, or for printed-circuits with high population densities. In these situations reflow soldering is often used.

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our "IC Package Databook" (order code 9398 652 90011).

#### Soldering by dipping or by wave

The maximum permissible temperature of the solder is 260 °C; solder at this temperature must not be in contact with the joint for more than 5 seconds. The total contact time of successive solder waves must not exceed 5 seconds.

The device may be mounted up to the seating plane, but the temperature of the plastic body must not exceed the specified maximum storage temperature ( $T_{stg\ max}$ ). If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature within the permissible limit.

#### Repairing soldered joints

Apply a low voltage soldering iron (less than 24 V) to the lead(s) of the package, below the seating plane or not more than 2 mm above it. If the temperature of the soldering iron bit is less than 300 °C it may remain in contact for up to 10 seconds. If the bit temperature is between 300 and 400 °C, contact may be up to 5 seconds.

### DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	

### LIFE SUPPORT APPLICATIONS

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